# 19"/2 ® CS2202



## **High-performance Xeon computer**

The 19"/2 ® CS2202 computer offers a rugged Military-Off-the-Shelf (MOTS) high-performance computer in a rugged half rack form factor. It comes with a powerful Xeon processor, removable M2 SSD disk and of course passively cooled.

#### Small form factor

The MilDef 19"/2 ® form factor is optimized for reduced size, weight, and power (SWaP) to meet industry and military requirements without sacrificing reliability, ruggedness or performance.

#### Flexible mounting

The 19"/2 ® standard enables flexible mounting options for a wide array of integration scenarios. The unit can be mounted in a standard 19" rack, half racks, or directly on to a surface and at any angle.

### Military-relevant rugged design

MilDef products are designed to operate in extreme environmental conditions and challenging electromagnetic operational scenarios. Operationally

proven, MilDef products are actively employed in military operations in over 60 countries.

## **Guaranteed performance**

MilDef products are designed for the long lifecycles of military programs and come with a lifetime support program to ensure your equipment maintains peak performance for many missions to come.

We also guarantee the availability of spare parts for an additional 5 years after product end-of-life.

#### **Features**

- Intel® HD Graphics P630
- Up to 64 GB RAM ECC
- Intel® Xeon® E-2276ML
- Replaceable CMOS battery
- TPM 2.0
- Passively cooled



Connector Interfaces	
SERVICE (back)	1x RS232 Service
X1 (front)	<ul><li>3x USB2.0</li><li>3x RS232</li></ul>
X2 (front)	<ul> <li>4x ETH 1000BASE-T</li> </ul>
X3 DC IN (front)	1x Power
X4 (back)	• 1x DVI
X5 (back)	<ul><li>1x VGA</li><li>1x Remote Power On</li><li>1x AUDIO</li></ul>
X7 (front)	<ul> <li>1x USB3.2 Gen 1</li> </ul>
X8 (front)	• 1x USB3.2 Gen 1

1x Battery cover (bottom)
1x MilDef M.2 disk slot (front)

1x System button (front)

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Technical Specification	
Blanking	Double-pressing the System button
Computer graphics	Intel® HD Graphics P630
Computer memory	Up to 64 GB RAM ECC
Computer processor	Intel® Xeon® E-2276ML
Graphics resolution	Max 1920 x 1200 @ 60Hz on all video interfaces
CMOS battery	Replaceable CMOS battery, located behind a cover for easy access
TPM	TPM 2.0
Electronics ground to chassis	Isolated
MIL-STD-1275D	5.3.2.2 5.3.2.3 5.3.2.4
Polarity protection	Protected against incorrect polarity connection on the power input within the normal operating voltage range
Power consumption	Idle 13 W (OS only) Typical 60 W (50% load, no USB load) Max 100 W (active disk heater,100% load, max USB load)
Power input	12-32 VDC
Power to chassis	Isolated
Power to electronics ground	Isolated
Chassis material	Aluminum

Coating and color	AE0305-6603120 Axalta (RAL 6031)
Cooling	Passively cooled
Dimensions width and heigh	t 220 x 43.4 mm (8.66 x 1.71 in) (WxH)
Earth point	M6 12 mm
Rack mounting depth	400 mm (15.8 in)
Surface treatment chassis	Chromit-Al
Unit depth	342 mm (13.5 in)
Weight	3.7 kg (8.2 lbs)
MTBF	119,147 h
CE	Compliant

### **Environmental Specification**

MIL-STD-810G, Method 516.6, crocedure I - Functional chock. Table 516.6-II, Terminal eak sawtooth pulse, Ground quipment 0 g
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High temperature - Operating	MIL-STD-810G, method 501.5, Procedure II - Operation 60 °C (140 °F)
High temperature - Storage	MIL-STD-810G, Method 501.5, Procedure I - Storage 71 °C (160 °F)
Humidity	MIL-STD-810G, Method 507.5, Procedure II - Aggravated 95 ± 4 % RH Ten 24 h cycles
IP Class (Solid Particle Protection)	IP Class 6X
IP Class (Water)	IP Class X5
Low air pressure - Rapid	MIL-STD-810G, Method

decompression	500.5, Procedure III - Rapid
	decompression
	75.2 kPa, corresponding to 2,438
	m (8,000 ft)
	17 kPa corresponding to 12 102

17 kPa, corresponding to 12,192 m (40,000 ft)

Low air pressure - Operating MIL-STD-810G, method 500.5, Procedure II - Operation/Air Carriage 4,572 m (15,000 ft)

Low temperature - Operating MIL-STD-810G, method 502.5, Procedure II - Operation

-40 °C (-40 °F)

Low temperature - Storage

MIL-STD-810G, method 502.5,
Procedure I - Storage
-40 °C (-40 °F)



Noise level	Maximum noise level of 40 dB SPL A-weighting at 1 m (3.3 ft) distance
Salt fog	MIL-STD-810G Method: 509.5 5 % $\pm$ 1 % (by weight) Two cycles, 24 h wet + 24 h dry / cycle
Temperature shock - Operating	MIL-STD 810G, method 503.5 procedures I - C, - Multi-cycle shocks from constant extreme temperature 55 °C (131 °F) -40 °C (-40 °F)
Vibration - Helicopter	MIL-STD-810G. Method 514.6, Procedure I - General vibration, Category 14 - Rotary wing aircraft - helicopter
Vibration - Loose cargo	MIL-STD-810G. Method 514.6, Procedure II - Loose cargo transportation, Category 5 - Truck/trailer - loose cargo
Vibration - Tracked vehicles	MIL-STD-810G. Method: 514.6 , Procedure 1 - General Vibration, Category 20 - Ground vehicles - ground mobile, tracked vehicles
Vibration - Wheeled vehicles	MIL-STD-810G. Method: 514.6, Procedure 1 - General Vibration, Category 20 - Ground vehicles - ground mobile, wheeled vehicles
EMC Specification	
EMI conducted CE102	MIL-STD-461F, Method CE102, Conducted emissions, power leads BASIC CURVE 10 kHz - 10 MHz
EMI radiated RE102	MIL-STD-461F, Method RE102,

Radiated emissions, electric field

MIL-STD-461F, Method CS101, Conducted susceptibility, power

MIL-STD-461F, Method CS114, Conducted bulk susceptibility

MIL-STD-461F, Method CS115, Conducted susceptibility, bulk cable injection, impulse excitation

MIL-STD-461F, Method CS116, Conducted susceptibility, damped sinusoidal transients, cables and power leads 10 kHz - 100 MHz

Navy Mobile & Army 2 MHz - 18 GHz

leads CURVE #1 30 Hz - 150 kHz

Army, Ground 10 kHz - 200 MHz EMS radiated RS103 MIL-STD-461F, Method RS103, Radiated susceptibility, electric field Army 2 MHz - 1 GHz



**EMS conducted CS101** 

**EMS conducted CS114** 

**EMS conducted CS115** 

**EMS conducted CS116**